| L Number | Hits | Search Text | DB | Time stamp |
|---|---|---|---|---|
| 1 | 967 | (fabry adj perot) or fabry-perot | EPO; JPO; IBM_TDB | 2003/01/29 15:46 |
| 2 | 1016834 | substrate or film or wafer | EPO; JPO; IBM_TDB | 2003/01/29 15:46 |
| 3 | 6 | ((fabry adj perot) or fabry-perot) and plasma | EPO; JPO; IBM_TDB | 2003/01/29 15:46 |
| 4 | 6 | (substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma) | EPO; JPO; IBM_TDB | 2003/01/29 15:46 |
| 5 | 93839 | etch or etching | EPO; JPO; IBM_TDB | 2003/01/29 15:46 |
| 6 | 4 | ((substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)) and (etch or etching) | EPO; JPO; IBM_TDB | 2003/01/29 15:47 |
| - | 268 | (356/519).CCLS. | USPAT; US-PGPUB | 2003/01/23 16:09 |
| - | 5185 | (fabry adj perot) or fabry-perot | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 158059 | plasma | USPAT; US-PGPUB | 2003/01/23 16:12 |
| - | 831115 | substrate or film or wafer | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 580 | ((fabry adj perot) or fabry-perot) and plasma | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 501 | (substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma) | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 161974 | etch or etching | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 335 | ((substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)) and (etch or etching) | USPAT; US-PGPUB | 2003/01/29 15:46 |
| - | 11 | 5225888.URPN. | USPAT | 2003/01/23 16:43 |
| - | 1 | "5907820".PN. | USPAT | 2003/01/23 16:56 |
| - | 1 | "5837094".PN. | USPAT | 2003/01/23 16:56 |
| - | 1 | "5719495".PN. | USPAT | 2003/01/23 16:56 |
| - | 1 | "5656902".PN. | USPAT | 2003/01/23 16:57 |
| - | 1 | "5654796".PN. | USPAT | 2003/01/23 16:57 |
| - | 138 | 356/454 | USPAT; US-PGPUB | 2003/01/28 11:40 |
| - | 11 | 5225888.URPN. | USPAT | 2003/01/28 11:49 |

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